MOSFET - Power, Single N-Channel

100 V, 12.2 mΩ, 47.1 A

NVMFS015N10MCL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFWS015N10MCL Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

	(1) = 23 (nse noteu)		
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	100	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	۱ _D	47.1	А
Current $R_{\theta JC}$ (Notes 1, 3)	State	T _C = 100°C		29.8	
Power Dissipation	Steady State	T _C = 25°C	PD	59.5	W
$R_{\theta JC}$ (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$		23.8	1
Continuous Drain	Steady	$T_A = 25^{\circ}C$	۱ _D	10.7	А
Current R _{θJA} (Notes 1, 2, 3)	State	$T_A = 100^{\circ}C$		6.8	
Power Dissipation	Steady State	$T_A = 25^{\circ}C$	PD	3.1	W
$R_{\theta JA}$ (Notes 1, 2)		T _A = 100°C		1.2	1
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	259	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			IS	49.6	А
Single Pulse Drain-to-Source Avalanche Energy (I _{AS} = 2.6 A)			E _{AS}	469	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.1	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	40.8	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
100 V	12.2 mΩ @ 10 V	47.1 A
100 V	18.3 mΩ @ 4.5 V	47.1 A





ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS				-			
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				60		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			1.0	_
		V _{DS} = 100 V	T _J = 125°C			250	0 μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)	•						
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 77 μA		1	1.5	3	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 14 A		9.7	12.2	
		V _{GS} = 4.5 V	I _D = 11 A		13.3	18.3	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =5 V, I _D = 14 A			51		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}				1338		1
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MH	z, V _{DS} = 50 V		521		pF
Reverse Transfer Capacitance	C _{RSS}				9.0		1
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 50 V; I_{D} = 14 A			9.0		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 50 V; I _D = 14 A			19		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 50 V; I _D = 14 A			2.0		nC
Gate-to-Source Charge	Q _{GS}				3.0		
Gate-to-Drain Charge	Q _{GD}				3.0		
Plateau Voltage	V _{GP}				2.7		V
SWITCHING CHARACTERISTICS (Note 5)				•		
Turn-On Delay Time	t _{d(ON)}				8.4		
Rise Time	tr	V _{CS} = 10 V. V _D	e = 50 V.		2.7		1
Turn-Off Delay Time	t _{d(OFF)}	$\begin{array}{l} V_{GS} = 10 \; V, \; V_{DS} = 50 \; V, \\ I_{D} = 14 \; A, \; R_{G} = 6.0 \; \Omega \end{array}$			23.8		ns
Fall Time	t _f				4.6		
DRAIN-SOURCE DIODE CHARACTERIS	TICS				•		
Source to Drain Diode Forward Voltage	ce to Drain Diode Forward Voltage V_{SD} V_{GS} = 0 V, I _S = 2 A				0.7	1.2	V
J		V _{GS} = 0 V, I _S = 14 A			0.83	1.3	1
Reverse Recovery Time	t _{rr}	I _F = 7 A, di/dt = 300 A/μs			20		ns
Reverse Recovery Charge	Q _{rr}				33		nC
Reverse Recovery Time	t _{rr}	I _F = 7 A, di/dt = 1000 A/μs			14		ns
Reverse Recovery Charge	Q _{rr}				76		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS015N10MCLT1G	015L10	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFWS015N10MCLT1G	015W10	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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